

Practitioner's Docket No. MI22-1572

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In re application of: Salman Akram

Application No.: 09/756,971
Filed: 01/09/01Group No.: 2827
Examiner: David A. ZarnekeRECEIVED
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JUL 13 2004

For: Methods of Forming Board-On-Chip Packages

Commissioner for Patents
Washington, D.C. 20231

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IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Application Serial No. 09/756,971
Filing Date January 9, 2001
Inventor Salman Akram
Assignee Micron Technology, Inc.
Group Art Unit 2827
Examiner David A. Zarneke
Attorney's Docket No. MI22-1572
Title: Methods of Forming Board-On-Chip Packages

SUPPLEMENTAL INFORMATION DISCLOSURE STATEMENT

References -See Attached Form PTO-1449

The Examiner's attention is directed to the references which are listed on the attached Form PTO-1449. No admission is made regarding whether the submitted references are prior art.

Citation of the referenced art is respectfully requested.

Respectfully submitted,

07/29/2004 AJON

Dated: 7-12-04

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180.00 DA

By: 

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